

Hyperfast Rectifier, 3 A FRED Pt®



Cathode Anode

DO-221AC (SlimSMA)

FEATURES

- Hyperfast recovery time, reduced Q_{rr} , and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, piezo-injection, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

| PRODUCT SUMMARY | |
|-----------------|--------------------|
| Package | DO-221AC (SlimSMA) |
| $I_{F(AV)}$ | 3 A |
| V_R | 200 V |
| V_F at I_F | 0.74 V |
| t_{rr} | 30 ns |
| T_J max. | 175 °C |
| Diode variation | Single die |

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|-------------------|-------------------------------|-------------|-------|
| Peak repetitive reverse voltage | V_{RRM} | $T_C = 145$ °C ⁽¹⁾ | 200 | V |
| Average rectified forward current | $I_{F(AV)}$ | | 3 | |
| Non-repetitive peak surge current | I_{FSM} | $T_J = 25$ °C | 85 | A |
| Operating junction and storage temperatures | T_J , T_{Stg} | | -65 to +175 | °C |

Note

⁽¹⁾ Device on PCB with 8 mm x 16 mm soldering lands

ELECTRICAL SPECIFICATIONS ($T_J = 25$ °C unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------------------|------------------|-----------------------------------|------|------|------|-------|
| Breakdown voltage, blocking voltage | V_{BR} , V_R | $I_R = 100$ µA | 200 | - | - | V |
| Forward voltage | V_F | | - | 0.86 | 0.93 | |
| Reverse leakage current | I_R | $I_F = 3$ A | - | 0.74 | 0.78 | µA |
| | | $I_F = 3$ A, $T_J = 125$ °C | - | 1 | 8 | |
| Junction capacitance | C_T | $V_R = V_R$ rated | - | - | 2 | pF |
| | | $T_J = 125$ °C, $V_R = V_R$ rated | - | 13 | - | |

| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified) | | | | | | |
|---|-----------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t_{rr} | $I_F = 1.0 \text{ A}$, $dI_F/dt = 50 \text{ A}/\mu\text{s}$, $V_R = 30 \text{ V}$ | - | 26 | - | ns |
| | | $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$ | - | - | 30 | |
| | | $T_J = 25^\circ\text{C}$ | - | 18 | - | |
| | | $T_J = 125^\circ\text{C}$ | - | 26 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25^\circ\text{C}$ | - | 2.5 | - | A |
| | | $T_J = 125^\circ\text{C}$ | - | 4 | - | |
| | I_{RRM} | $I_F = 3 \text{ A}$ $dI_F/dt = 200 \text{ A}/\mu\text{s}$ $V_R = 160 \text{ V}$ | - | 2.5 | - | |
| | | $T_J = 125^\circ\text{C}$ | - | 4 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25^\circ\text{C}$ | - | 23 | - | nC |
| | | $T_J = 125^\circ\text{C}$ | - | 50 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-------------------|--|--------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T_J , T_{Stg} | | -65 | - | 175 | °C |
| Thermal resistance, junction to case | R_{thJC} | Device mounted on PCB with 8 mm x 16 mm soldering lands | - | - | 10 | °C/W |
| Thermal resistance, junction to ambient | R_{thJA} | Device mounted on PCB with 2 mm x 3.5 mm soldering lands | - | - | 110 | |
| Approximate Weight | | | 0.032 | | | g |
| | | | 0.0011 | | | oz. |
| Marking device | | Case style DO-221AC (SlimSMA) | 3H2 | | | |

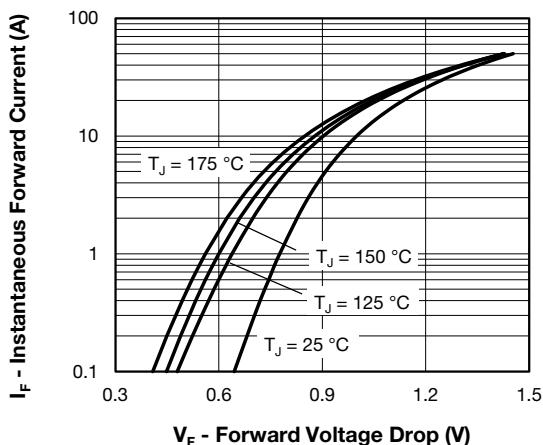


Fig. 1 - Typical Forward Voltage Drop Characteristics

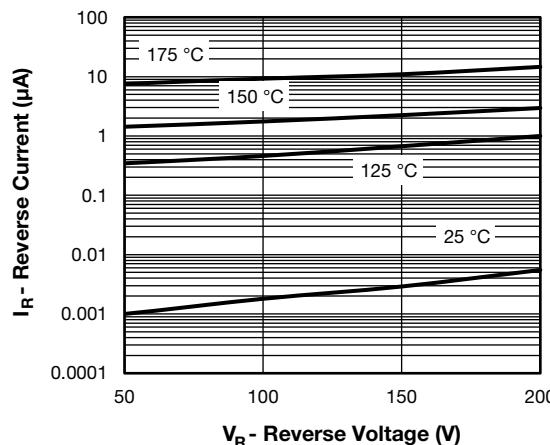


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

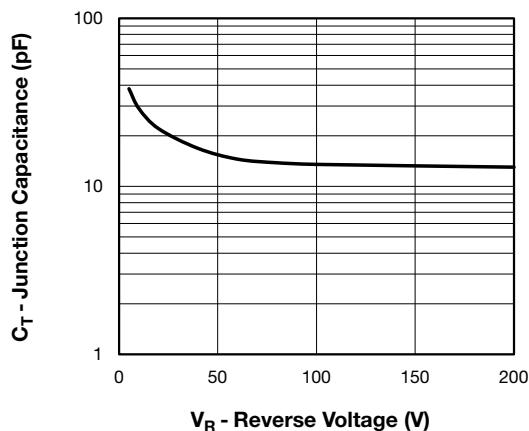


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

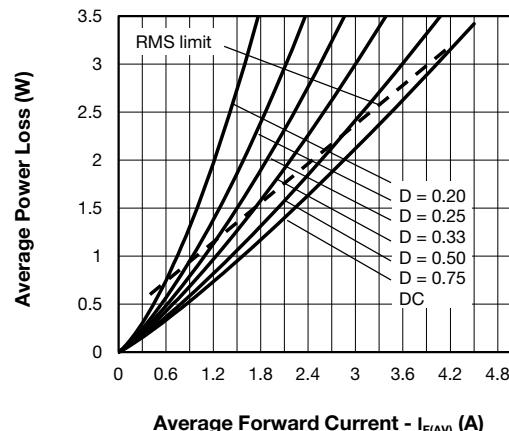


Fig. 5 - Forward Power Loss Characteristics

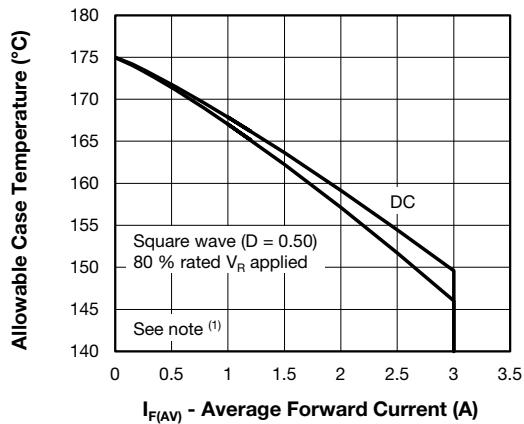


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

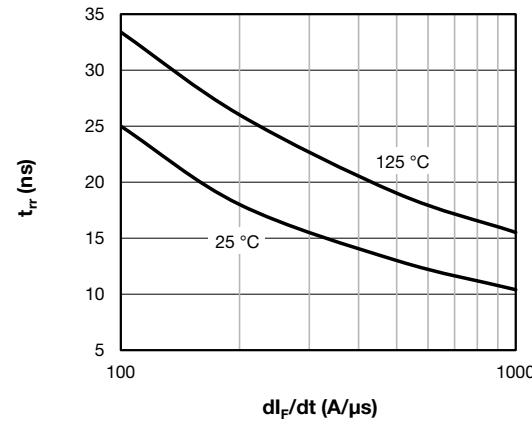


Fig. 6 - Typical Reverse Recovery vs. dI_F/dt

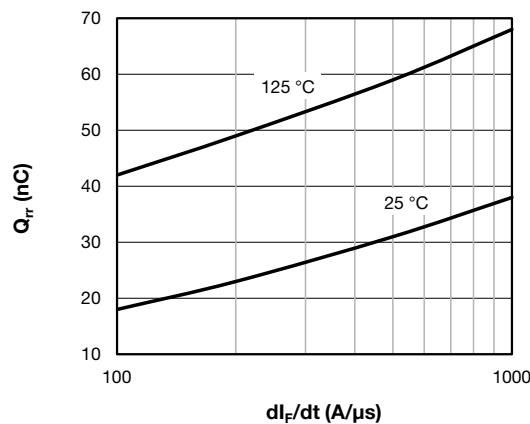


Fig. 7 - Typical Stored Charge vs. dI_F/dt

Note

(1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see Fig. 6);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

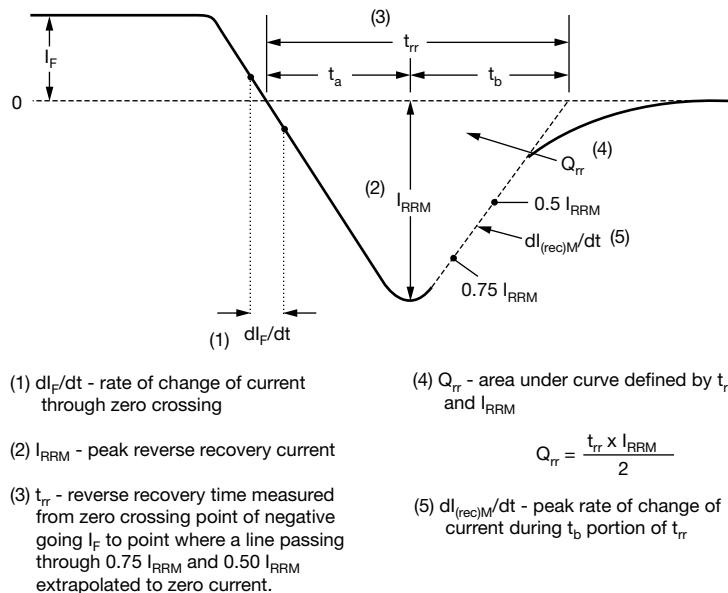


Fig. 8 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

| | | | | | | | | |
|-------------|-----|---|---|---|---|----|---|----|
| Device code | VS- | 3 | E | J | H | 02 | H | M3 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |

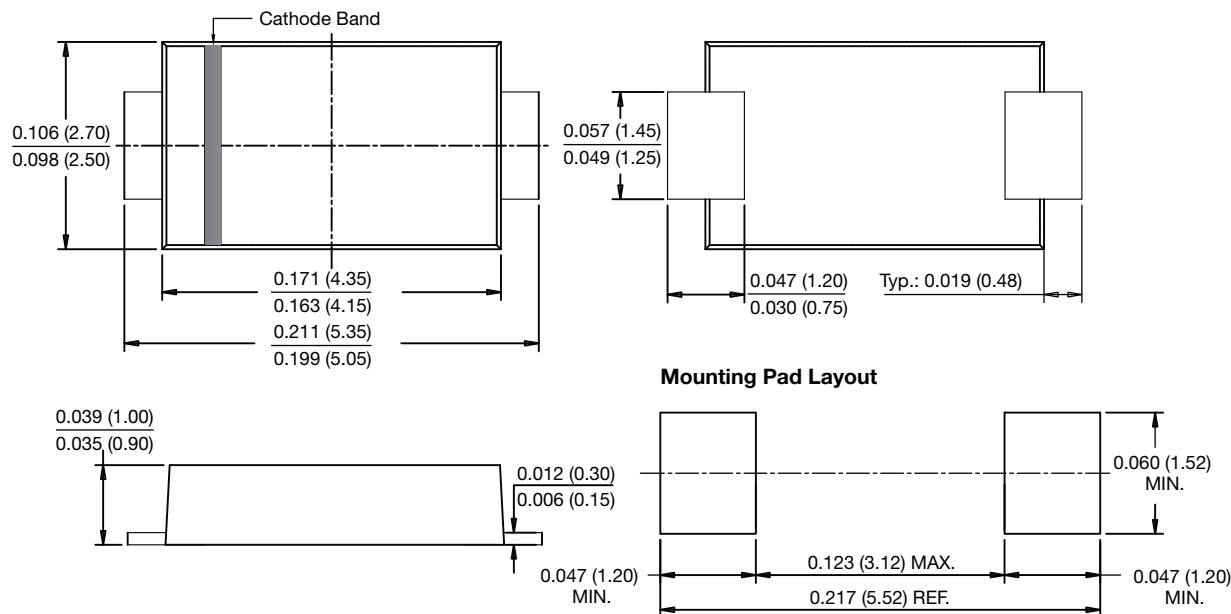
- 1** - Vishay Semiconductors product
- 2** - Current rating (3 = 3 A)
- 3** - Circuit configuration:
E = single diode
- 4** - J = SlimSMA package
- 5** - Process type,
H = hyperfast recovery
- 6** - Voltage code (02 = 200 V)
- 7** - H = AEC-Q101 qualified
- 8** - M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|--------------------------------|-------------------|------------------------|------------------------------------|
| PREFERRED P/N | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-3EJH02HM3/6A | 3500 | 3500 | 7" diameter plastic tape and reel |
| VS-3EJH02HM3/6B | 14 000 | 14 000 | 13" diameter plastic tape and reel |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?95571 |
| Part marking information | www.vishay.com/doc?95562 |
| Packaging information | www.vishay.com/doc?88869 |
| SPICE model | www.vishay.com/doc?96050 |

DO-221AC (SlimSMA)

DIMENSIONS in inches (millimeters)



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